As the below named inventor, I hereby declare as follows:

My residence, post office address and citizenship are as stated below next to my name.

I believe that I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## REVERSIBLE BINDING OF MOLECULES TO METAL SUBSTRATES THROUGH AFFINITY INTERACTIONS

the Application of which ws filed in the United States Patent and Trademark office on May 15, 2000, and assigned application Serial No. 09/571,084.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge the duty to disclose information of which I am aware that is material to the examination of this application in accordance with 37 CFR 1.56(a).

I do not know and do not believe: that this invention was ever known or used in the United States of America before my invention thereof; that this invention was patented or described in any printed publication in any country before my invention thereof or more than one year prior to this application; that this invention was in public use or on sale in the United States of America more than one year prior to this application; that this invention has been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months prior to this application; nor that any application for patent or inventor's certificate on this invention has been filed in any country foreign to the United States of America prior to this application by me or my legal representatives or assigns.

I hereby appoint the following to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith:

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William B. Anderson, Reg. No. 41,595 Victoria L. Boyd, Reg. No. 43,510 Y. Ping Chow, Reg. No. 30,740 James A. Fox, Reg. No. 38,455 Derek P. Freyberg, Reg. No. 29,250 Walter Kurz, Reg. No. 37,373 Edward Lynch, Reg. No. 24,422 Priscilla H. Mark, Reg. No. 41,970 William Schmonsees, Reg. No. 31,796 Soodabeh Tronson, Reg. No. 41,354 Herwig von Morzé, Reg. No. 29,484

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of this application or any patent issuing thereon.

SOLE INVENTOR	INVENTOR'S SIGNATURE	DATE
Jaime E. Ramirez-Vick	more	10-30-2000
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